

32 N Gould St., Sheridan, WY 82801, USA

Tel.: +1 (786) 825 8645 Email: sales@thinfilmmaterials.com WhatsApp: Keyue Advanced Materials Website: www.thinfilmmaterials.com

Certificate of Analysis (CoA)

Aug. 11, 2025

Product Name: Antimony Sulfide – Copper Composite Sputtering Target

Chemical Formula: $Sb_2S_3 - Cu$ (95:5 at%)

Purity: 99.99% (4N, excluding intentional elements) **Target Dimensions**: Ø76.2 mm × 3.0 mm (±0.1 mm)

Backing Plate: Elastomer bonded to Copper plate, Ø76.2 mm × 3.0 mm

Lot Number: CSJM-250711TB

Manufactured by: Thin-Film Materials

Physical Description

Form: Composite sputtering target

• Appearance: Dark gray to black, brittle solid with metallic inclusions

Crystal Structure: Orthorhombic Sb₂S₃ + FCC Cu

Fabrication: Hot pressing, machining, indium bonding to Cu plate

• Theoretical Density: ~4.8–5.0 g/cm³ (composite)

Nominal Atomic Composition

Component Formula Atomic %

Antimony Sulfide Sb₂S₃ 95

Copper Cu 5

Chemical Purity of Raw Materials (by ICP-OES)

Element Symbol Min. Purity

 Sb
 Sb
 99.999%

 S
 S
 99.999%

 Cu
 Cu
 99.999%

Impurity Analysis (Composite Target)



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Element Symbol Max. Content (ppm)

Iron Fe <15
Lead Pb <10
Silver Ag <10
Other trace elements (each) — <10

Total Impurities – <100 ppm

Handling & Storage

- Brittle material; handle carefully to prevent cracking.
- Store in vacuum-sealed or inert atmosphere packaging.
- Avoid exposure to moisture or corrosive gases.
- Handle with clean gloves to prevent contamination.

Declaration

We certify that the above product has been manufactured using high-purity raw materials and tested according to our quality management system. The product meets the specifications stated herein.

Chen Giang

Authorized Signature:

Inspection Certificate by: Nancy Liu

Approver by: Chen Qiang